


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	PACKAGE STRUCTURE COMPATIBLE WITH COOLING SYSTEM		
Application Type : regular, utility Attorney Docket Number : 10353-US-PA-0P			
Correspondence address: Customer Number: 31561 			
Continuing Data: This is a Continuation-in-part of US application number 10605081, filed 2003-09-08 , now pending.			
Priority Data: Doc.No: 92103999; Country -TW ; Date: 2003-02-26 us-priority-claimed			
Inventors Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: TW Name prefix: Mr. Given Name: Tsung-Yueh Family Name: Tsai Residence: City of Residence: Kaohsiung Country of Residence: TW Address-1 of Mailing Address: No. 27, Chianhe Rd., Gangshan Jen Address-2 of Mailing Address: City of Mailing Address: Kaohsiung State of Mailing Address: Postal Code of Mailing Address: 820 Country of Mailing Address: TW Phone: Fax: E-mail:			

Inventor 2:

Applicant Authority Type: Inventor
Citizenship: TW
Name prefix: Mr.
Given Name: Sheng-Yang
Family Name: Peng
Residence:
City of Residence: Kaohsiung
Country of Residence: TW
Address-1 of Mailing Address: No. 2, Alley 9, Lane 98, Dahenghe Rd., Sanmin Chiu
Address-2 of Mailing Address:
City of Mailing Address: Kaohsiung
State of Mailing Address:
Postal Code of Mailing Address: 807
Country of Mailing Address: TW
Phone:
Fax:
E-mail:

Attorney Information:

practitioner(s) at Customer Number:

31561



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.